

Pages 1 to 100

# LIST OF PUBLISHED ESCC DOCUMENTS AND SPECIFICATIONS

# **ESCC REP001**

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LIST OF PUBLISHED ESCC SPECIFICATIONS

Page:

2

Issue:

2

## CHANGE DESCRIPTION

This issue supersedes Issue 04/01, dated June 2004.



LIST OF PUBLISHED ESCC SPECIFICATIONS

Page:

3

2

Issue:

# **TABLE OF CONTENTS**

			raye	
Intro	Introduction			
Class	s of	Document/Specification Families		
<u>Publi</u>	ic.			
02	_	Policy (Level 0)	8	
-	_	Organisation Documents (Level 1(0))	8	
	-	Support Documents (Level 1(1))	8	
	-	Implementation Documents (Level 1(2))	8	
03	-	Basic Specifications (Level 2)	9	
		CAPACITORS		
79	-	Sectional Basic Specifications for Capacitors	11	
04	-	Ceramic (3001/)	12	
05	-	Tantalum Solid (3002/)	13	
06	-	Tantalum Gelled (3003/)	14	
07	-	Glass (3004/)	15	
09	-	Plastic Metallised (3006/)	16	
10	-	Mica (3007/)	17	
11	-	Filter (3008/)	18	
48	-	Chip Ceramic Dielectric (3009/)	19	
49	-	Variable (3010/)	20	
66	-	Chip Tantalum Solid Electrolyte (3011/)	21	
71	-	Leadless Surface Mounted Ta. Solid Electrolyte Enclosed Anode Connection (3012/)	22	
		MICROWAVE WAVEGUIDE		
63	-	Power Dividers Couplers RF Waveguide (3102/)	23	
12	-	RF COILS (3201/)	24	
70	_	FERRITE MICROWAVE COMPONENTS (3202/)	25	
		<u></u> (		
		CONNECTORS		
83	-	Sectional Basic Specifications for Electrical Connectors	26	
13	-	Multicontact (3401/)	27	
14	-	Coaxial (3402/)	29	
80	-	Filtered Circular and Rectangular (3405/)	30	
58	-	ATTENUATORS AND LOADS (3403/)	31	
62	-	POWER DIVIDERS (3404/)	32	
		QUARTZ CRYSTALS		
93	_	Sectional Basic Specifications for Quartz Crystals	33	
93 15	-	Quartz Crystals (3501/)	33 34	
13	-	Quartz Orystais (000 1/)	34	
69	-	SURFACE ACOUSTIC WAVE (SAW) DEVICES (3502/)	35	



LIST OF PUBLISHED ESCC SPECIFICATIONS

Page: 4
Issue: 2

			Page
		RELAYS	
76 16	-	Sectional Basic Specifications for Relays Non-Latching (3601/)	36 37
17	_	Latching (3602/)	38
92	-	RF Coaxial Switch Latching (3603/)	39
		<u>SWITCHES</u>	
59 67	-	Toggle Switches (3701/) Thermostatic Switches (3702/)	40 41
		CABLES	
10			40
19 20	-	L.F. (3901/) R.F. (3902/)	42 43
82	-	Solid Wires 350V for Wire Wrapping (3903/)	44
		RESISTORS	
84	-	Sectional Basic Specifications for Resistors	45
21	-	Film and Metal Oxide (4001/)	46
22	-	Wire-wound Precision (4002/)	47
23	-	Wire-wound Chassis-mounted (4003/)	48
25	-	Network Thick Film (4005/)	49
57 64	-	Thermistors (4006/)	50 51
04	-	Heaters (4009/)	31
		DISCRETE SEMICONDUCTORS	
26 61	-	Transistors and Diodes (Generic and Sectional Basic Specifications) (5000)  Microwave Semiconductor Components (Generic and Sectional Basic Specification) (5010)	52 53
		TRANSISTORS	
27	_	Low Power NPN (5201/)	54
28	-	Low Power PNP (5202/)	55
29	-	High Power NPN (5203/)	56
30	-	High Power PNP (5204/)	57
31	-	FET N Channel (5205/)	58
32	-	FET P Channel (5206/)	59
33	-	Multiple (5207/)	60
34	-	Switching (5208/)	61
		OPTO-ELECTRONIC DEVICES	
50	-	Photocouplers (5401/)	62
55	-	Emitters (5402/)	63
		DIODES	
36	_	Switching (5101/)	64
37	-	Voltage Reference (5102/)	65
38	-	Rectifier (5103/)	66
53	-	Schottky (5106/)	67
54	-	Miscellaneous (5107/)	68



LIST OF PUBLISHED ESCC SPECIFICATIONS

Page: 5

Issue:

2

			Page
		MICROWAVE DIODES	
72	-	Oscillator (5511/)	69
	-	Small Signal (5512/)	70
74	-	Large Signal (5513/)	71
		MICROWAVE TRANSISTORS	
86	-	Silicon Small Signal Transistors (5611/)	73
77	-	III-V Small Signal Transistors (5613/)	74
87	-	III-V Large Signal And Oscillators (5614/)	75
90	-	Passive Devices	76
		INTEGRATED CIRCUITS	
41	-	Linear C.MOS Bipolar etc (Generic and Sectional Basic Specifictions) (9000)	77
42	-	Linear (91/)	78
43	-	C.MOS 4000 Series	79
47	-	Others	83
68	-	54HCMOS Series	84
		Complex Devices/Microprocessors (95/)	88
75	-	ACMOS Series	89
		CHARGE COUPLED DEVICES	
78	-	CCD. Generic and Sectional Basic Specifications (9020)	92
81	-	CCD. Photo MOS Area Arrays (9610/)	93
		MONOLITHIC MICROWAVE INTEGRATED CIRCUITS	
88	-	MMIC. Generic and Sectional Basic Specifications	94
89	_	MMIC. Linear Gain (9012/)	95
ANI	NEX	I: Correlation Listing of IC Specifications/Types/Classes of Publications	
		Sorted by Part Type Number	96

### **INTRODUCTION**

This list comprises all ESCC documents and specifications which were published and under configuration control on the 29<sup>th</sup> November 2005 .

The ESCC documents and specifications are classified according to 5 levels, viz:

LEVEL 0 - Policy

LEVEL 1 - 1(0) Organisation Documents.

1(1) Support Documents.

1(2) Implementation Documents.

LEVEL 2 - Basic Specifications.

LEVEL 3 - Generic Specifications.

LEVEL 4 - Detail Specifications.

However, to facilitate retrieval, they are not classified according to the above levels, but by the various classes of publication listed in the table of contents.

The ESCC documents are available from the ESCC web site: https://spacecomponents.org

The ESCC specifications are available from the ESCIES web site: https://escies.org.

CD-ROM images are also provided on the ESCIES web site.

If access to the web sites is not possible, queries may be directed to the secretariat:

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LIST OF PUBLISHED ESCC SPECIFICATIONS

Page:

Issue:

: 2

7